



## INA133 INA2133

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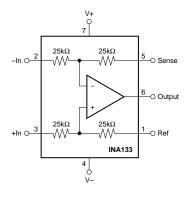
# High-Speed, Precision DIFFERENCE AMPLIFIERS

#### **FEATURES**

- DESIGNED FOR LOW COST
- SINGLE, DUAL VERSIONS
- LOW OFFSET VOLTAGE DRIFT: ±450μV max, ±5μV/°C max
- LOW GAIN ERROR: 0.05% max
- WIDE BANDWIDTH: 1.5MHz
- HIGH SLEW RATE: 5V/µs
- FAST SETTLING TIME: 5.5µs to 0.01%
- LOW QUIESCENT CURRENT: 950μA
- WIDE SUPPLY RANGE: ±2.25V to ±18V
- SO-8 and SO-14 PACKAGES

#### DESCRIPTION

The INA133 and INA2133 are high slew rate, unity-gain difference amplifiers consisting of a precision op amp with a precision resistor network. The on-chip resistors are laser trimmed for accurate gain and high common-mode rejection. Excellent TCR tracking of the resistors maintains gain accuracy and common-mode rejection over temperature. They operate over a wide supply range,  $\pm 2.25$ V to  $\pm 18$ V ( $\pm 4.5$ V to  $\pm 36$ V single supply), and input common-mode voltage range extends beyond the positive and negative supply rails.

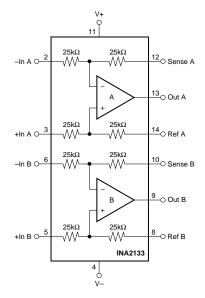


#### **APPLICATIONS**

- DIFFERENTIAL INPUT AMPLIFIER BUILDING BLOCK
- DIFF IN/DIFF OUT AMPLIFIER
- UNITY-GAIN INVERTING AMPLIFIER
- GAIN = +1/2 OR G = +2 AMPLIFIER
- SUMMING AMPLIFIER
- SYNCHRONOUS DEMODULATOR
- CURRENT/DIFFERENTIAL LINE RECEIVER
- VOLTAGE-CONTROLLED CURRENT SOURCE
- BATTERY POWERED SYSTEMS
- LOW COST AUTOMOTIVE

The differential amplifier is the foundation of many commonly used circuits. The low cost INA133 and INA2133 provide this precision circuit function without using an expensive precision network.

The single version, INA133, package is the SO-8 surface mount. The dual version, INA2133, package is the SO-14 surface mount. Both are specified for operation over the extended industrial temperature range,  $-40^{\circ}$ C to  $+85^{\circ}$ C. Operation is from  $-55^{\circ}$ C to  $+125^{\circ}$ C.



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Twx: 910-952-1111 • Internet: http://www.burr-brown.com/ • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

## $\label{eq:SPECIFICATIONS: VS} \textbf{SPECIFICATIONS: VS} = \pm 15 \text{V}$ At TA = +25°C, VS = ±15V, RL = 10kΩ connected to ground, and reference pin connected to ground, unless otherwise noted.

		INA133U INA2133U			ı				
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP MAX		UNITS	
OFFSET VOLTAGE <sup>(1)</sup> Initial <sup>(1)</sup> vs Temperature	RTO $V_{CM} = 0V$ $T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$		±150 ±2	±450 ±5	Se	* e Typical Cu	±900 irve	μV μV/°C	
vs Power Supply vs Time Channel Separation (dual)	$V_{S} = \pm 2.25 \text{V to } \pm 18 \text{V}$ dc		±10 0.3 120	±30		900	±50	μV/V μV/√mo dB	
INPUT IMPEDANCE <sup>(2)</sup> Differential Common-Mode	$V_{CM} = 0V$		50 25			*		kΩ kΩ	
INPUT VOLTAGE RANGE Common-Mode Voltage Range Positive Negative Common-Mode Rejection Ratio	$V_O = 0V$ $V_O = 0V$ $V_{CM} = -27V \text{ to } +27V, R_S = 0\Omega$	2(V+) -3 2(V-) +3 80	2(V+) -2 2(V-) +2 90		* * 74	* *		V V dB	
OUTPUT VOLTAGE NOISE <sup>(3)</sup> f = 0.1Hz to 10Hz  f = 10Hz  f = 100Hz  f = 1kHz	RTO		2 80 60 57			* * * *		μVp-p nV/√Hz nV/√Hz nV/√Hz	
GAIN Initial Error vs Temperature Nonlinearity	$V_O = -14V \text{ to } +13.5V$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_O = -14V \text{ to } +13.5V$		1 ±0.02 ±1 ±0.0001	±0.05 ±10 ±0.001		* * *	±0.1 * ±0.002	V/V % ppm/°C % of FS	
OUTPUT Voltage Output Positive Negative Positive Negative Current Limit, Continuous-to-Common Capacitive Load (stable operation)	Gain Error < 0.1% $R_L = 10 k\Omega \text{ to Ground}$ $R_L = 10 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$	(V+) -1.5 (V-) +1	(V+)-1.3 (V-)+0.8 (V+)-0.8 (V-)+0.3 -25/+32 1000		*	* * * * *		V V V mA pF	
FREQUENCY RESPONSE Small-Signal Bandwidth Slew Rate Settling Time: 0.1% 0.01% Overload Recovery Time	-3dB 10V Step, $C_L = 100$ pF 10V Step, $C_L = 100$ pF 50% Overdrive		1.5 5 4 5.5 4			* * * *		MHz V/μs μs μs μs	
POWER SUPPLY Rated Voltage Operating Voltage Range Dual Supplies		±2.25	±15	±18	*	*	*	V	
Single Supply Quiescent Current (per amplifier)	I <sub>O</sub> = 0	+4.5	±0.95	+36 ±1.2	*	*	*	V mA	
		-40 -55 -55		+85 +125 +125	* * *		* * *	°C °C °C	
SO-8 Surface Mount SO-14 Surface Mount			150 100			*		°C/W °C/W	

<sup>\*</sup> Specifications the same as INA133U, INA2133U.

NOTES: (1) Includes the effects of amplifier's input bias and offset currents. (2)  $25k\Omega$  resistors are ratio matched but have  $\pm 20\%$  absolute value. (3) Includes effects of amplifier's input current noise and thermal noise contribution of resistor network.

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## SPECIFICATIONS: $V_S = \pm 5V$

At  $T_A = +25^{\circ}C$ ,  $V_S = \pm 5V$ ,  $R_L = 10k\Omega$  connected to ground, and reference pin connected to ground, unless otherwise noted.

		INA133U INA2133U			ı			
PARAMETER	PARAMETER CONDITIONS		NS MIN TYP MAX		MIN	TYP	MAX	UNITS
OFFSET VOLTAGE <sup>(1)</sup> Initial <sup>(1)</sup> vs Temperature	RTO V <sub>CM</sub> = 0V		±300 ±2	±750		*	±1500	μV μV/°C
INPUT VOLTAGE RANGE Common-Mode Voltage Range Positive Negative Common-Mode Rejection Ratio	$V_{O} = 0V$ $V_{O} = 0V$ $V_{CM} = -7V \text{ to } +7V, R_{S} = 0\Omega$	2(V+) -3 2(V-) +3 80	2(V+) -2 2(V-) +2 90		* * 74	* * *		V V dB
GAIN Initial Gain Error Nonlinearity	$V_{O} = -4V \text{ to } 3.5V$ $V_{O} = -4V \text{ to } 3.5V$		1 ±0.02 ±0.0001	±0.05 ±0.001		* *	±0.1 ±0.002	V/V % % of FS
OUTPUT Voltage Output Positive Negative Positive Negative Negative	Gain Error < 0.1% $R_L = 10 k\Omega \text{ to Ground}$ $R_L = 10 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$ $R_L = 100 k\Omega \text{ to Ground}$	(V+) -1.5 (V-) +1	(V+) -1.3 (V-) +0.8 (V+) -0.8 (V-) +0.3		*	* * *		V V V
POWER SUPPLY Rated Voltage Operating Voltage Range Dual Supplies Single Supply Quiescent Current (per amplifier)	-		±15	±18 +36 ±1.2	*	*	* * *	V V V mA

<sup>\*</sup> Specifications the same as INA133U, INA2133U.

NOTES: (1) Includes the effects of amplifier's input bias and offset currents.

#### **ABSOLUTE MAXIMUM RATINGS(1)**

Supply Voltage, V+ to V	36V
Input Voltage Range	
Output Short-Circuit (to ground)(2)	Continuous
Operating Temperature	55°C to +125°C
Storage Temperature	55°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	+300°C

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. (2) One channel per package.



This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

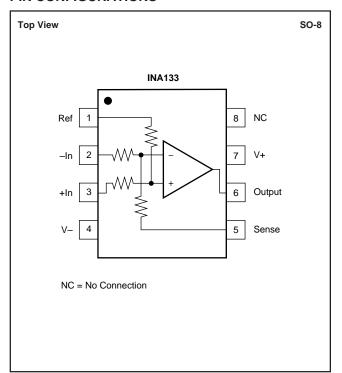
#### PACKAGE/ORDERING INFORMATION

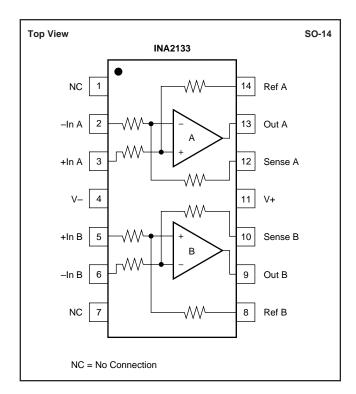
PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER <sup>(2)</sup>	TRANSPORT MEDIA
Single INA133U " INA133UA	SO-8 Surface Mount " SO-8 Surface Mount "	182 " 182	-40°C to +85°C " -40°C to +85°C	INA133U " INA133UA	INA133U INA133U/2K5 INA133UA INA133UA/2K5	Rails Tape and Reel Rails Tape and Reel
Dual INA2133U " INA2133UA	SO-14 Surface Mount " SO-14 Surface Mount "	235 " 235 "	-40°C to +85°C -40°C to +85°C	INA2133U " INA2133UA "	INA2133U INA2133U/2K5 INA2133UA INA2133UA/2K5	Rails Tape and Reel Rails Tape and Reel

NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "INA133UA/2K5" will get a single 2500-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book.

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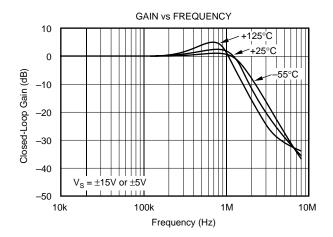
#### **PIN CONFIGURATIONS**

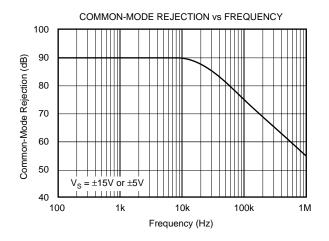


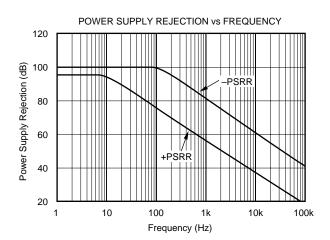


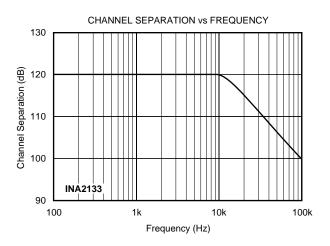
## **TYPICAL PERFORMANCE CURVES**

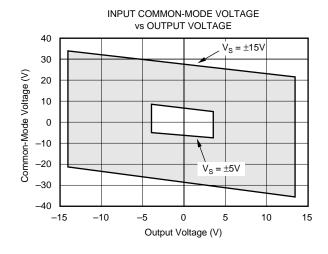
At  $T_A = +25^{\circ}C$ ,  $V_S = \pm 15V$ ,  $R_L = 10k\Omega$  connected to ground, and reference pin connected to ground, unless otherwise noted.

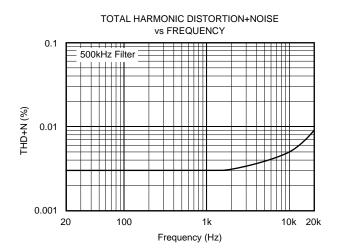






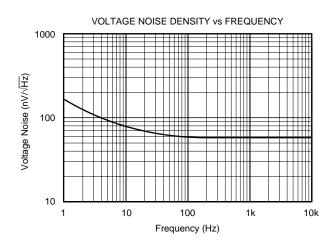


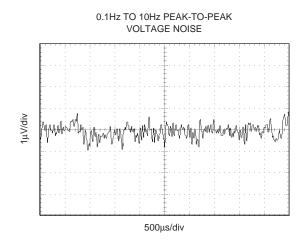


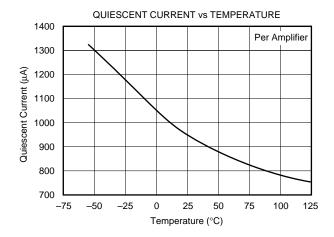


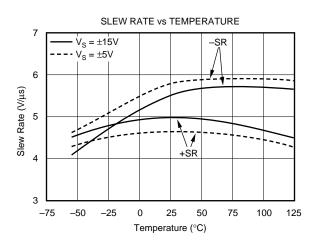
## TYPICAL PERFORMANCE CURVES (CONT)

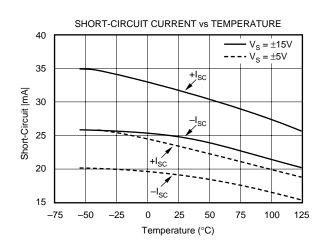
At  $T_A = +25^{\circ}C$ ,  $V_S = \pm 15V$ ,  $R_L = 10k\Omega$  connected to ground, and reference pin connected to ground, unless otherwise noted.

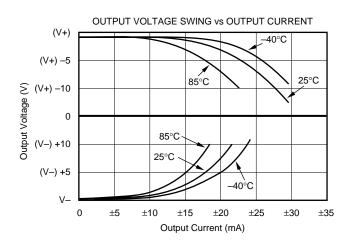






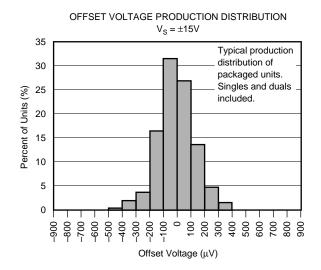


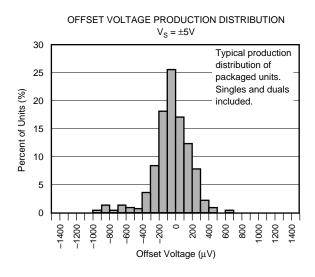


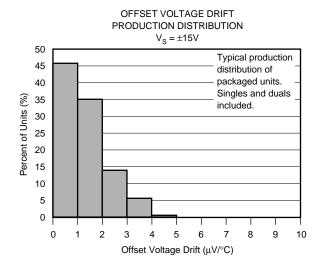


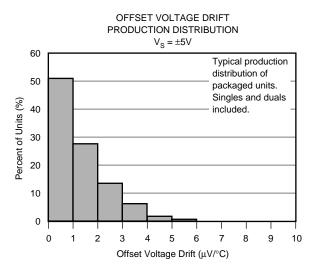
## TYPICAL PERFORMANCE CURVES (CONT)

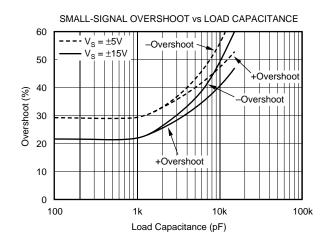
At  $T_A = +25^{\circ}C$ ,  $V_S = \pm 15V$ ,  $R_L = 10k\Omega$  connected to ground, and reference pin connected to ground, unless otherwise noted.

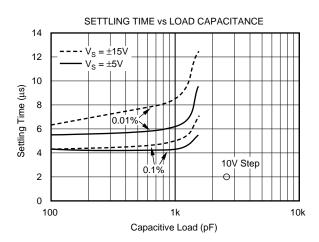






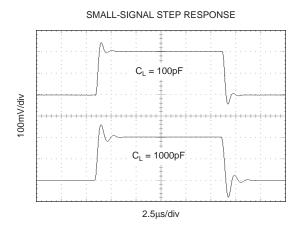


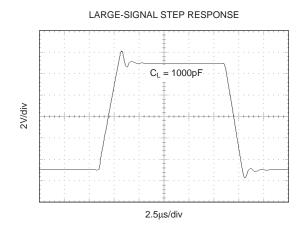


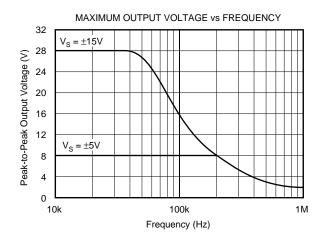


## TYPICAL PERFORMANCE CURVES (CONT)

At  $T_A$  = +25°C,  $V_S$  = ±15V,  $R_L$  = 10k $\Omega$  connected to ground, and reference pin connected to ground, unless otherwise noted.







#### APPLICATIONS INFORMATION

The INA133 and INA2133 are high-speed difference amplifiers suitable for a wide range of general purpose applications. Figure 1 shows the basic connections required for operation of the INA133. Decoupling capacitors are strongly recommended in applications with noisy or high impedance power supplies. The capacitors should be placed close to the device pins as shown in Figure 1. All circuitry is completely independent in the dual version assuring lowest crosstalk and normal behavior when one amplifier is overdriven or short-circuited.

As shown in Figure 1, the differential input signal is connected to pins 2 and 3. The source impedances connected to the inputs must be nearly equal to assure good common-mode rejection. A  $5\Omega$  mismatch in source impedance will degrade the common-mode rejection of a typical device to approximately 80dB (a  $10\Omega$  mismatch degrades CMR to 74dB). If the source has a known impedance mismatch, an additional resistor in series with the opposite input can be used to preserve good common-mode rejection.

The INA133's internal resistors are accurately ratio trimmed to match. That is,  $R_1$  is trimmed to match  $R_2$  and  $R_3$  is trimmed to match  $R_4$ . However, the absolute values may not be equal  $(R_1+R_2$  may be slightly different than  $R_3+R_4$ ). Thus, large series resistors on the input (greater than 250 $\Omega$ ), even if well matched, will degrade common-mode rejection.

Circuit board layout constraints might suggest possible variations in connections of the internal resistors. For instance, it appears that pins 1 and 3 could be interchanged. However, because of the ratio trimming technique used (see paragraph above) CMRR will be degraded. If pins 1 and 3 are inter-

FIGURE 1. Precision Difference Amplifier (Basic Power Supply and Signal Connections).

changed, pins 2 and 5 must also be interchanged to maintain proper ratio matching.

#### **OPERATING VOLTAGE**

The INA133 and INA2133 operate from single ( $\pm 4.5V$  to  $\pm 36V$ ) or dual ( $\pm 2.25V$  to  $\pm 18V$ ) supplies with excellent performance. Specifications are production tested with  $\pm 5V$  and  $\pm 15V$  supplies. Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage are shown in the Typical Performance Curves.

#### **INPUT VOLTAGE**

The INA133 and INA2133 can accurately measure differential signals that are above and below the supply rails. Linear common-mode range extends from 2 • (V+)–3V to 2 • (V–) +3V (nearly twice the supplies). See the typical performance curve, "Input Common-Mode Voltage vs Output Voltage."

#### **OFFSET VOLTAGE TRIM**

The INA133 and INA2133 are laser trimmed for low offset voltage and drift. Most applications require no external offset adjustment. Figure 2 shows an optional circuit for trimming the output offset voltage. The output is referred to the output reference terminal (pin 1), which is normally grounded. A voltage applied to the Ref terminal will be summed with the output signal. This can be used to null offset voltage as shown in Figure 2. The source impedance of a signal applied to the Ref terminal should be less than  $10\Omega$  to maintain good common-mode rejection.

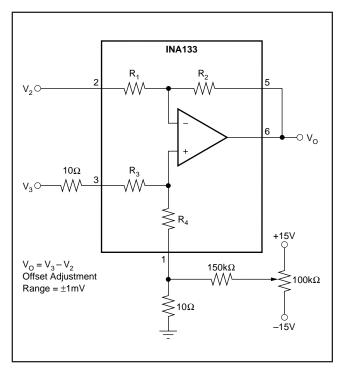
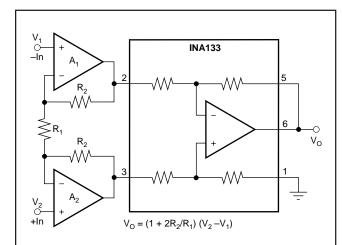


FIGURE 2. Offset Adjustment.



## **TYPICAL APPLICATIONS**



The INA133 can be combined with op amps to form a complete instrumentation amplifier with specialized performance characteristics. Burr-Brown offers many complete high performance IAs. Products with related performances are shown at the right in the table below.

A <sub>1</sub> , A <sub>2</sub>	FEATURE	SIMILAR COMPLETE BURR-BROWN IA
OPA2227	Low Noise	INA103
OPA129	Ultra Low Bias Current (fA)	INA116
OPA2277	Low Offset Drift, Low Noise	INA114, INA128
OPA2130	Low Power, FET-Input (pA)	INA121
OPA2234	Single Supply, Precision, Low Power	INA122, INA118
OPA2237	Single Supply, Low Power, MSOP-8	INA122, INA126

FIGURE 3. Precision Instrumentation Amplifier.

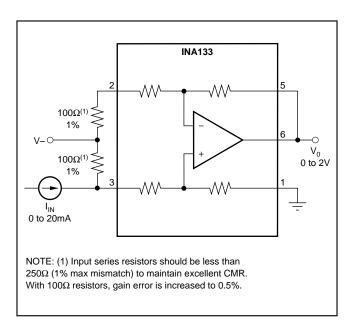


FIGURE 4. Current Receiver with Compliance to Rails.

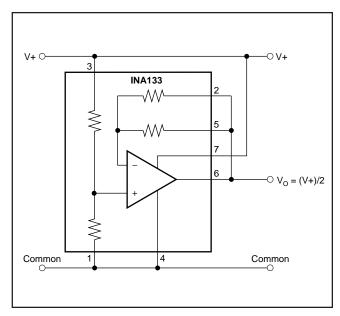


FIGURE 5. Pseudoground Generator.

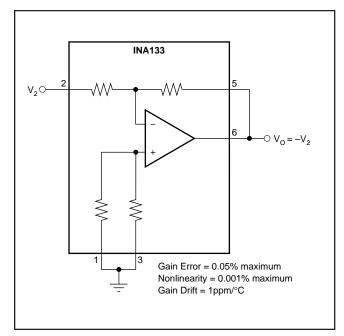


FIGURE 6. Precision Unity-Gain Inverting Amplifier.

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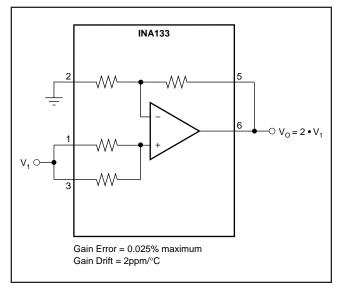


FIGURE 7. Precision Gain = 2 Amplifier.

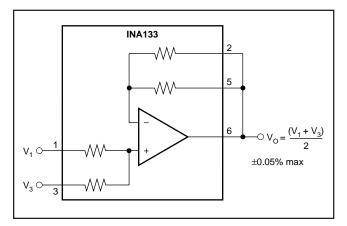


FIGURE 9. Precision Average Value Amplifier.

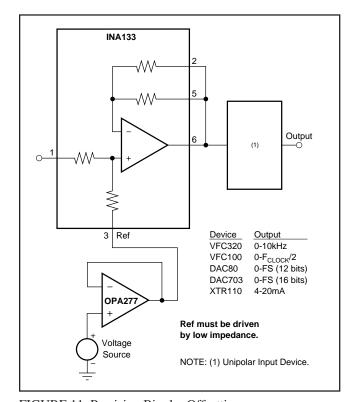


FIGURE 11. Precision Bipolar Offsetting.

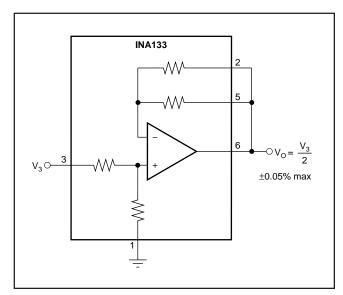


FIGURE 8. Precision Gain = 1/2 Amplifier.

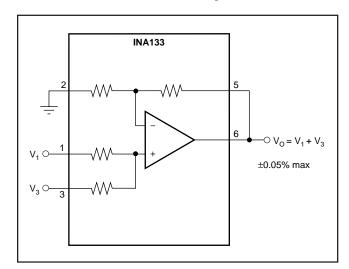


FIGURE 10. Precision Summing Amplifier.

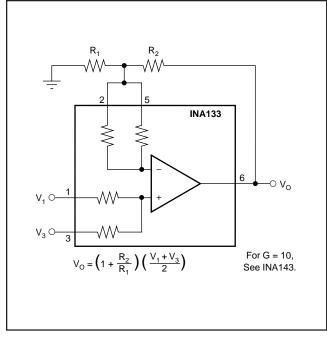


FIGURE 12. Precision Summing Amplifier with Gain.



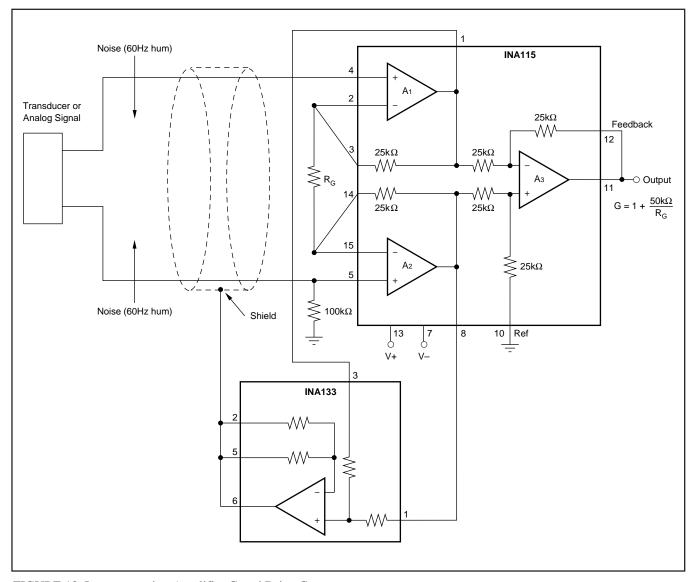


FIGURE 13. Instrumentation Amplifier Guard Drive Generator.

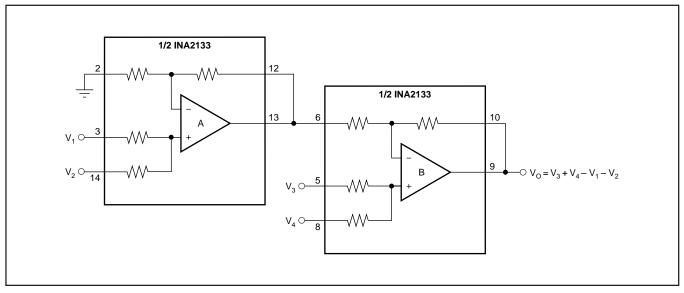


FIGURE 14. Precision Summing Instrumentation Amplifier.

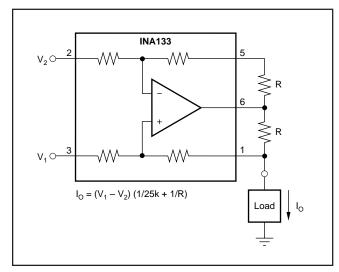


FIGURE 15. Precision Voltage-to-Current Converter with Differential Inputs.

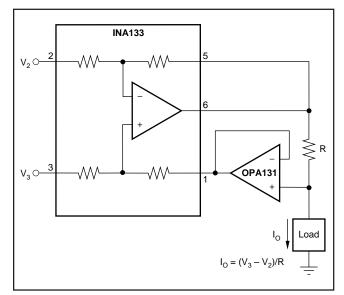


FIGURE 16. Differential Input Voltage-to-Current Converter for Low  $I_{OUT}$ .

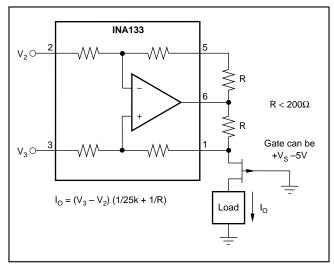


FIGURE 17. Isolating Current Source.

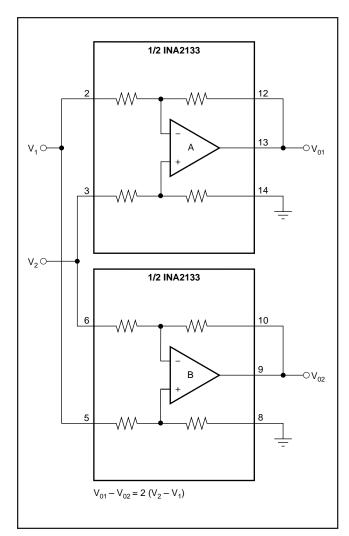


FIGURE 18. Differential Output Difference Amplifier.

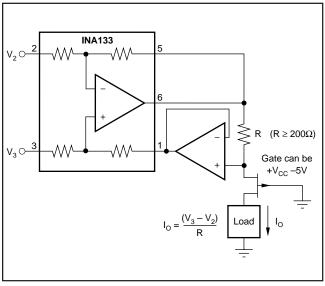


FIGURE 19. Isolating Current Source with Buffering Amplifier for Greater Accuracy.

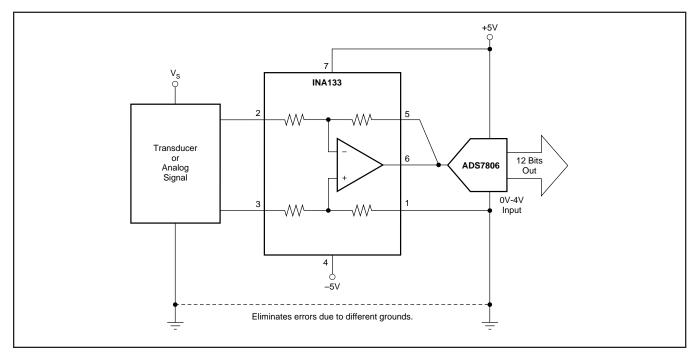


FIGURE 20. Differential Input Data Acquisition.

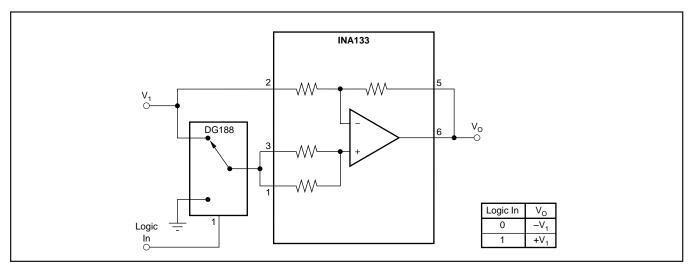


FIGURE 21. Digitally Controlled Gain of ±1 Amplifier.

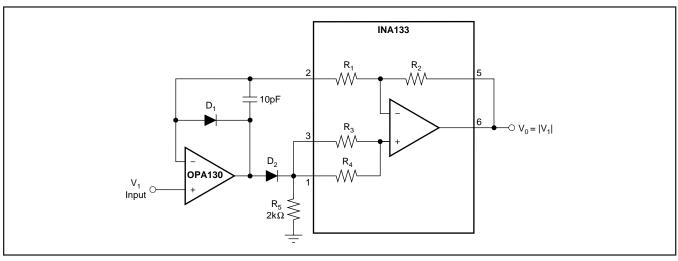
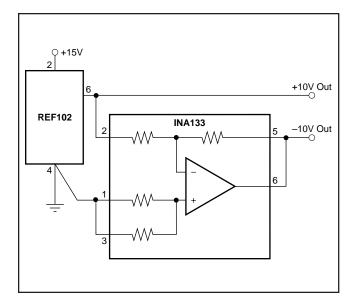


FIGURE 22. Precision Absolute Value Buffer.



INA133

BUF634 inside feedback loop contributes no error.

5

BUF634 inside feedback loop contributes no error.

5

RL

FIGURE 23. ±10V Precision Voltage Reference.

FIGURE 24. High Output Current Precision Difference Amplifier.

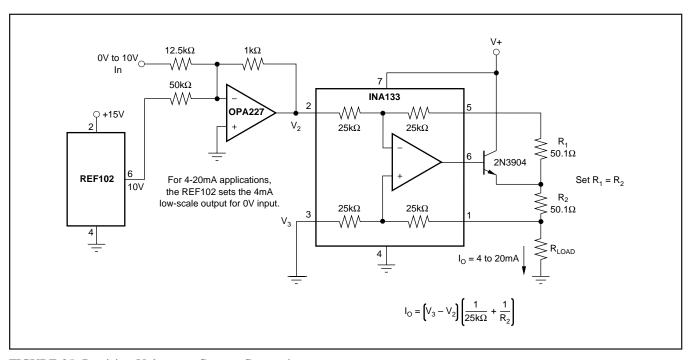


FIGURE 25. Precision Voltage-to-Current Conversion.

#### PACKAGE OPTION ADDENDUM

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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
INA133U	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA133U/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA133U/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA133UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	Call TI	Level-3-260C-168 HR
INA133UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA133UA/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA133UAE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	Call TI	Level-3-260C-168 HR
INA133UE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133U	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133U/2K5E4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
INA2133UA	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133UA/2K5E4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
INA2133UAE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133UAG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133UE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA2133UG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



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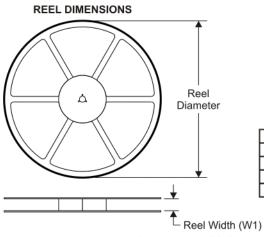
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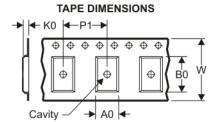
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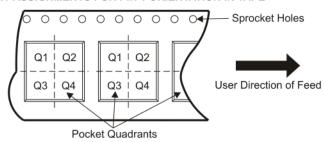
#### TAPE AND REEL INFORMATION





		Dimension designed to accommodate the component width
		Dimension designed to accommodate the component length
K	0	Dimension designed to accommodate the component thickness
٧	٧	Overall width of the carrier tape
ГР	1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA133U/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA133UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA133U/2K5	SOIC	D	8	2500	346.0	346.0	29.0
INA133UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0

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